

MOSFET

Metal Oxide Semiconductor Field Effect Transistor

CoolMOS™ P6

600V CoolMOS™ P6 Power Transistor IPZ60R070P6

Data Sheet

Rev. 2.0 Final





1 **Description**

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ P6 series combines the experience of the leading SJ MOSFET supplier with high class innovation. The offered devices provide all benefits of a fast switching SJ MOSFET while not sacrificing ease of use. Extremely low switching and conduction losses make switching applications even more efficient, more compact, lighter and cooler.

PG-TO 247-4

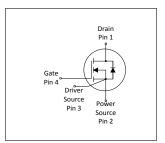
Features

- Increased MOSFET dv/dt ruggedness
- Extremely low losses due to very low FOM Rdson*Qg and Eoss
- Very high commutation ruggedness
- Best in class R_{DS(on)} /package
- Easy to use/drive due to driver source pin for better control of the gate
- Pb-free plating, Halogen free mold compound

for e.g. Computing, Server, Telecom and UPS.

- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)
- 4-pin kelvin source concept

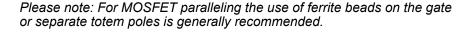
Applications







IPZ60R070P6



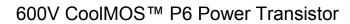
PFC stages, hard switching PWM stages and resonant switching stages



Table 1 **Key Performance Parameters**

Table 1 Rey Ferrormance Farameters									
Parameter	Value	Unit							
V _{DS} @ T _{j,max}	650	V							
R _{DS(on),max}	70	mΩ							
$Q_{g.typ}$	100	nC							
I _{D,pulse}	156	A							
E _{oss} @400V	12.3	μJ							
Body diode di/dt	250	A/µs							

Type / Ordering Code	Package	Marking	Related Links
IPZ60R070P6	PG-TO 247-4	6R070P6	see Appendix A





IPZ60R070P6

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2 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Douguestou	0		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	53.5 33.8	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	156	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	1136	mJ	I_D =9.3A; V_{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	1.72	mJ	I_D =9.3A; V_{DD} =50V; see table 10	
Avalanche current, repetitive	I _{AR}	_	-	9.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	_	-	100	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30 V AC		AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	391	W	<i>T</i> _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	46.3	Α	T _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	156	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	15	V/ns	V_{DS} =0400V, I_{SD} <= I_{S} , T_{j} =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	250	A/μs	V-0-0 400V los<-10 T-25°C	

 $^{^{1)}}$ Limited by $T_{j\;max}.$ Maximum duty cycle D=0.75 $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical \textit{R}_{G}



3 Thermal characteristics

Table 3 Thermal characteristics

Developed	Cumbal		Values		11	Note / Test Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.32	°C/W	-	
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	leaded	
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	



4 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Correction I		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_{D} =1mA	
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.72{\rm mA}$	
Zero gate voltage drain current	I _{DSS}	-	- 10	5	μΑ	V _{DS} =600, V _{GS} =0V, T _j =25°C V _{DS} =600, V _{GS} =0V, T _j =150°C	
Gate-source leakage current	I _{GSS}	_	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.063 0.164	0.070	Ω	V _{GS} =10V, I _D =20.6A, T _j =25°C V _{GS} =10V, I _D =20.6A, T _j =150°C	
Gate resistance	R _G	-	1	-	Ω	f=1MHz, open drain	

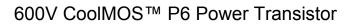
Table 5 **Dynamic characteristics**

Danamatan	Oh a l	Values			11:4	Note / Test Condition	
Parameter Symbol Min. Ty		Тур.	Max.	Unit			
Input capacitance	Ciss	-	4750	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz	
Output capacitance	Coss	-	190	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz	
Effective output capacitance, energy related ¹⁾	$C_{ m o(er)}$	-	150	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	703	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	$t_{ m d(on)}$	-	21	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9	
Rise time	t _r	-	14	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	62	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9	
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13 V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Parameter	Symbol Values Unit		nit Note / Test Condition				
Farameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	30	-	nC	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V	
Gate to drain charge	$Q_{ m gd}$	-	35	-	nC	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V	
Gate charge total	Q_g	-	100	-	nC	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V	
Gate plateau voltage	V _{plateau}	-	6.1	-	V	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V	

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V





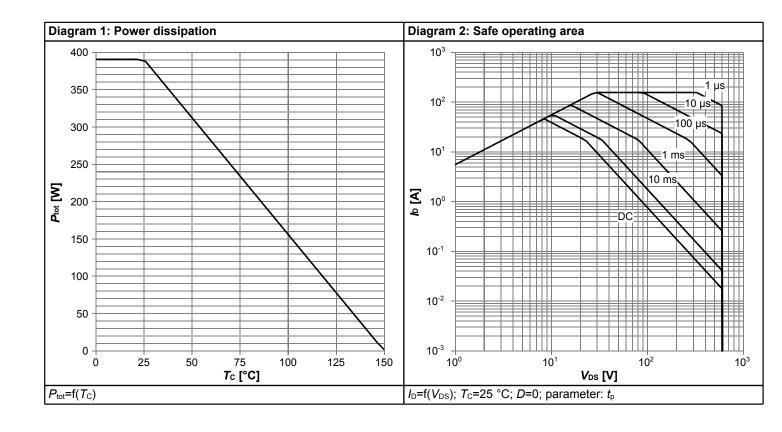
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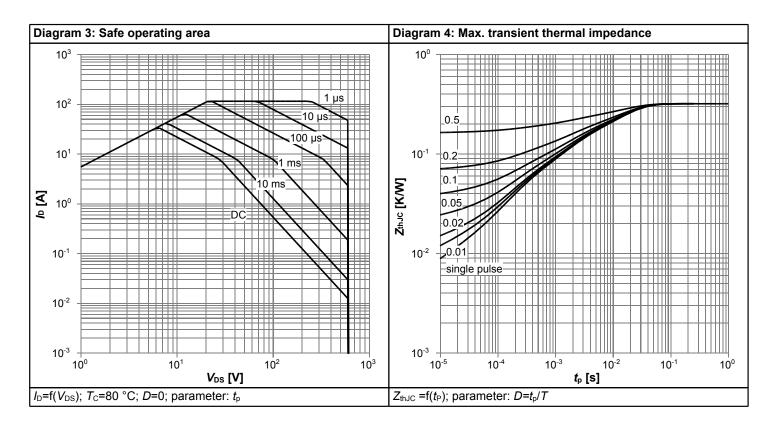
Table 7 Reverse diode characteristics

Downwater	Cymphal	Values		11:4	nit Note / Test Condition		
Parameter	meter Symbol		Тур.	Max.	Unit	Note / Test Condition	
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =25.8A, T _j =25°C	
Reverse recovery time	t _{rr}	-	520	-	ns	V_R =400V, I_F =25.8A, di_F/dt =100A/ μ s; see table 8	
Reverse recovery charge	Qrr	-	12	-	μC	V_R =400V, I_F =25.8A, di_F/dt =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	44	_	A	V_R =400V, I_F =25.8A, di_F/dt =100A/ μ s; see table 8	

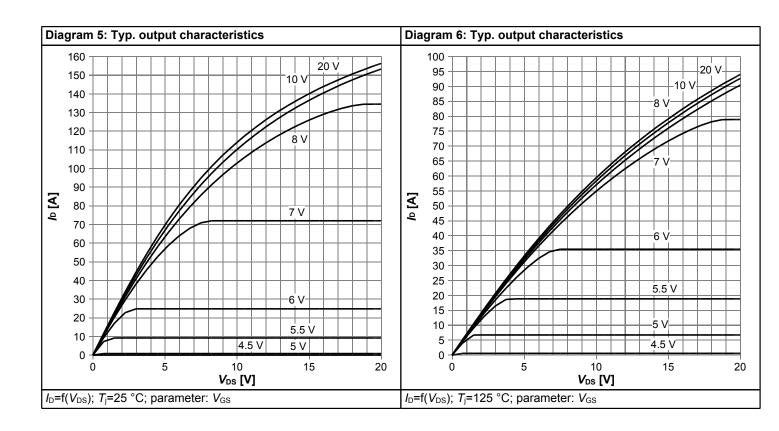


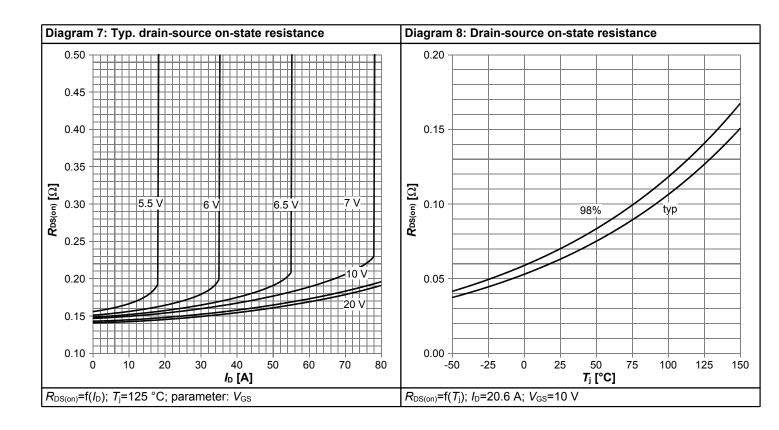
5 Electrical characteristics diagrams



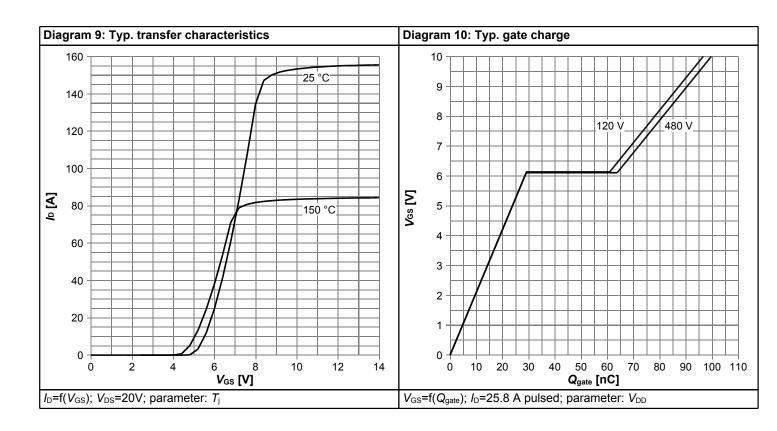


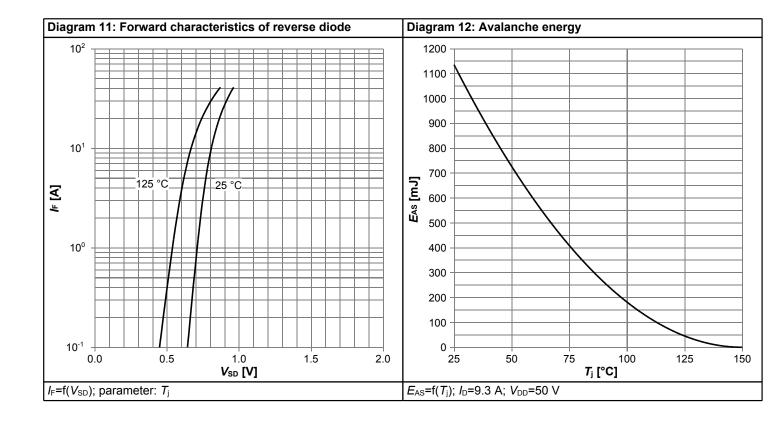




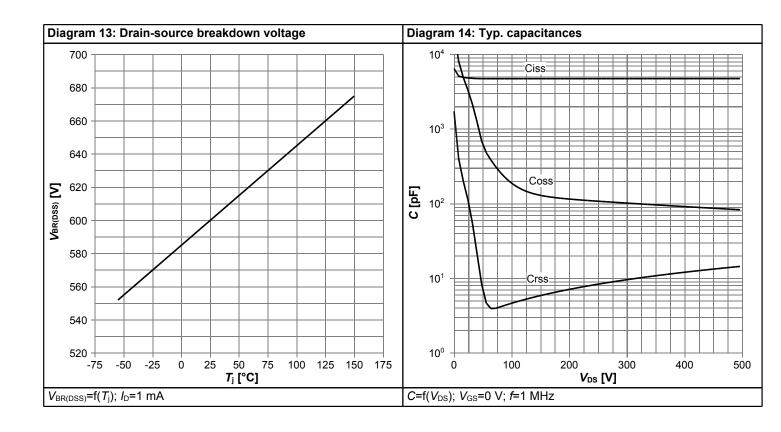


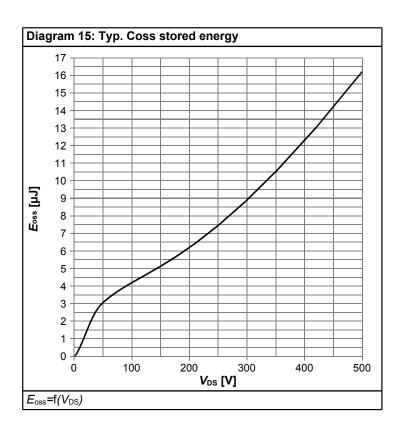














6 Test Circuits

Table 8 Diode characteristics

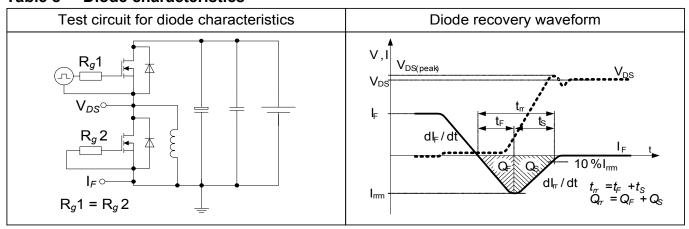


Table 9 switching times (ss)

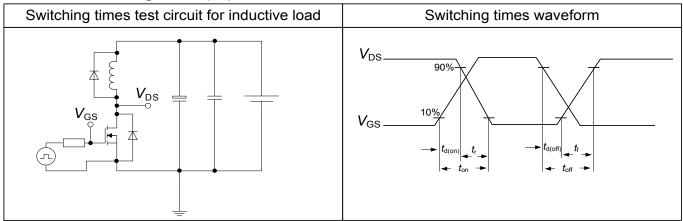
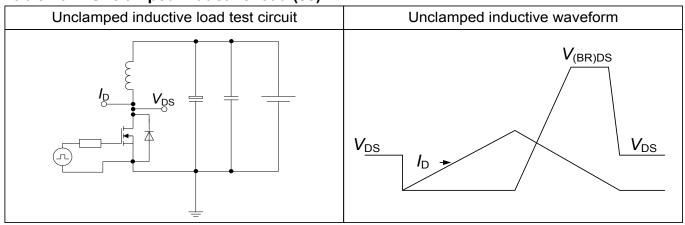
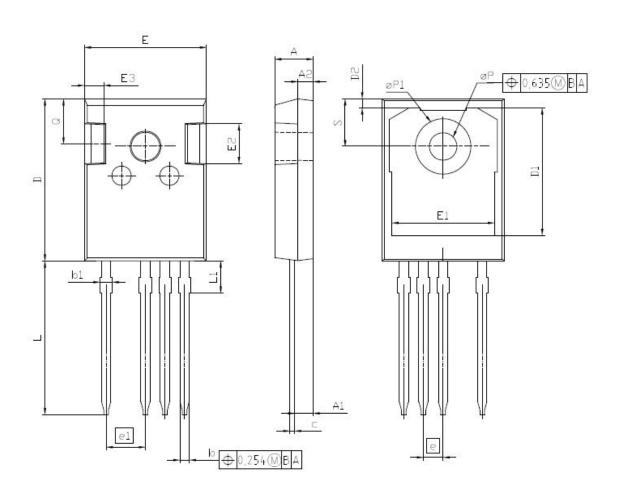


Table 10 Unclamped inductive load (ss)





7 Package Outlines



DIM	MILLIM	ETERS	INCI	HES
MIN MAX		MIN	MAX	
Α	4.83	5.21	0.190	0.205
A1	2.29	2.54	0.090	0.100
A2	1.90	2.16	0.075	0.085
b	1.07	1.33	0.042	0.052
b1	1.10	1.70	0.043	0.067
С	0.50	0.70	0.020	0.028
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
е	2.54	(BSC)	0.100	(BSC)
e1	5.	08	0.2	00
N		4		4
L	19.72	20.32	0.776	0.800
L1	4.02	4.40	0.158	0.173
øP	3.50	3.70	0.138	0.146
øP1	7.00	7.40	0.276	0.291
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

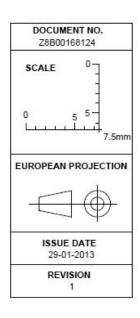


Figure 1 Outline PG-TO 247-4



8 Appendix A

Table 11 Related Links

- IFX CoolMOS[™] P6 Webpage: www.infineon.com
- IFX CoolMOS[™] P6 application note: www.infineon.com
- IFX CoolMOS[™] P6 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com



600V CoolMOS™ P6 Power Transistor

IPZ60R070P6

Revision History

IPZ60R070P6

Revision: 2015-07-13, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2015-07-13	Release of final version

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